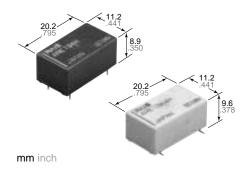
NAIS

SMALL MICROWAVE RELAYS FOR BROADCASTING INDUSTRY

RE-RELAYS



FEATURES

 \bullet Excellent high frequency characteristics (Impedance 75 $\!\Omega)$

• •	•	
Frequency	900MHz	2.6GHz
V.S.W.R. (Max.)	1.2	1.5
Insertion loss (dB, Max.)	0.2	0.5
Isolation (dB, Min.)	60	30

Surface-mount terminal (type) also available

SPECIFICATIONS

Contact

$Rating \begin{tabular}{l lllllllllllllllllllllllllllllllllll$						
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Arrangement		1 Form C			
$Rating \begin{tabular}{l lllllllllllllllllllllllllllllllllll$	Contact material			Gold		
$Rating \\ Rating \\ Contact carrying power \\ Contact $	Initial contact re	sistance		Max. 100mΩ		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Rating	Contact ra	ting	(at 2.6 GHz, Impedance 75 Ω, V.S.W.R. Max.1.5) 10mA 24V DC		
$\begin{tabular}{ l l l l l l l l l l l l l l l l l l l$		Contact ca	arrying power	Impedance 75 Ω ,		
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		Max. switch	hing voltage	30 V DC		
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		Max. switch	hing current	0.5 A DC		
$ \begin{array}{c} \text{characteristics} \\ \text{(Impedance} \\ 75\Omega) \end{array} \\ \hline \\ \text{Insertion loss} \\ \hline \\ \text{Min. 60dB (to 900MHz} \\ \text{Min. 30dB (to 2.6GHz} \\ \text{Min. 30dB (to 2.6GHz} \\ \text{Min. 30dB (to 2.6GHz} \\ \text{Impedance 75}\Omega, \\ \text{V.S.W.R. } \& 1.5 \\ \hline \\ \text{10mA 24V DC} \\ \text{(resistive load)} \\ \text{(at 20cpm)} \\ \hline \\ \hline \end{array} \\ \hline \\ \text{3×10}^5 \\ \hline \\ \text{3×10}^5 \\ \hline \\ \text{3×20}^5 \\ \hline \\ \text{10mA 24V DC} \\ \hline \\ \text{(resistive load)} \\ \text{(at 20cpm)} \\ \hline \\ \hline \end{array}$	High frequency	V.S.W.R.		Max. 1.2 (to 900MHz) Max. 1.5 (to 2.6GHz)		
Isolation Min. 30dB (to 3-00M nz Min. 30dB (to 2.6GHz Min. 30dB (to	characteristics (Impedance	Insertion le	oss	Max. 0.2 (to 900MHz) Max. 0.5 (to 2.6GHz)		
Expected life (min. operations) Electrical 1W, 2.6GHz, Impedance 75Ω, V.S.W.R. & 1.5 10mA 24V DC (resistive load) (at 20cpm) 3×10 ⁵		Isolation		Min. 60dB (to 900MHz) Min. 30dB (to 2.6GHz)		
Expected life (min. operations)	(min. opera-	Mechanica	al (at 180 cpm)	106		
10mA 24V DC (resistive load) 3×10 ⁵ (at 20cpm)		Flootrical	Impedance 75Ω ,	3×10 ⁵		
		Liectifical	(resistive load)	3×10⁵		
Coil (at 20°C, 68°F)						

Nominal operating power	200 mW
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Characteristics

Initial insulation resistance*1			Min. 100 MΩ (at 500 V DC)		
	Between open contacts		ntacts	500 Vrms	
Initial breakdown	Between contact and coil			1,000 Vrms	
voltage*2	Between contact and ground terminal			500 Vrms	
Operate time*3 (at 20°C)			Max. 10ms		
Release time (without diode)*3 (at 20°C)			Max. 5ms		
Temperature rise (at 20°C)*4			Max. 60°C		
Shock resistance		Fund	ctional*5	Min. 500 m/s ² {50 G}	
		Destructive*6		Min. 1,000 m/s ² {100 G}	
Vibration resistance		Functional*7		10 to 55 Hz at double amplitude of 3 mm	
		Destructive		10 to 55 Hz at double amplitude of 5 mm	
Conditions for operation, transport and storage*8 (Not freezing and condensing at low temperature)		Ambient temp.	-40°C to 60°C -40°F to 140°F		
		Humidity	5 to 85% R.H.		
Unit weight		Approx. 5 g .18 oz			

Remarks

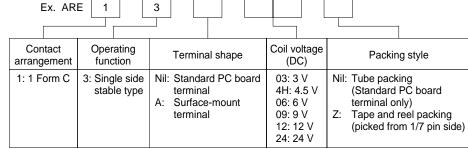
- * Specifications will vary with foreign standards certification ratings.
- *1 Measurement at same location as "Initial breakdown voltage" section.
- *2 Detection current: 10mA
- *3 Nominal operating voltage applied to the coil, excluding contact bounce time.
- *4 By resistive method, nominal voltage applied to the coil: Contact carrying power: 10W, at 2.6GHz, Impedance 75 Ω , V.S.W.R. & 1.5
- *5 Half-wave pulse of sine wave: 11ms, detection time: 10µs.
- *6 Half-wave pulse of sine wave: 6ms
- *7 Detection time: 10µs
- *8 Refer to 5. Conditions for operation, transport and storage mentioned in NOTES

TYPICAL APPLICATIONS

Broadcasting market

- Set Top Box (CS/BS tuner, CATV tuner)
- Multi-function TV
- Measuring instruments for broadcasting

ORDERING INFORMATION



Note: Tape and reel packing symbol "-Z" is not marked on the relay.

"X type tape and reel packing (picked from 8/9/10/11/12/13/14-pin side) is also availabe. Suffix "X" instead of "Z".

TYPES AND COIL DATA (at 20°C 68°F)

- Packing of standard PC board terminal: 50 pcs. in an inner package (tube); 500 pcs. in an outer package.
- Packing of surface-mount terminal: 400 pcs. in an inner package (tape and reel); 800 pcs. in an outer package.

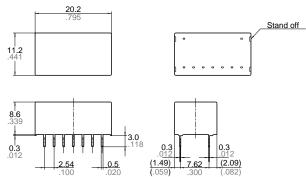
Standard PC board terminal	Surface-mount terminal	Nominal voltage, V DC	Pick-up voltage, V DC (max.) (initial)	Drop-out voltage, V DC (min.)(initial)	Coil resistance, Ω (±10%)	Nominal operating current, mA (±10%)	Nominal oper- ating power, mW	Max. allowable voltage, V DC
ARE1303	ARE13A03	3	2.25	0.3	45	66.7	200	3.3
ARE134H	ARE13A4H	4.5	3.375	0.45	101	44.4	200	4.95
ARE1306	ARE13A06	6	4.5	0.6	180	33.3	200	6.6
ARE1309	ARE13A09	9	6.75	0.9	405	22.2	200	9.9
ARE1312	ARE13A12	12	9	1.2	720	16.7	200	13.2
ARE1324	ARE13A24	24	18	2.4	2,880	8.3	200	26.4

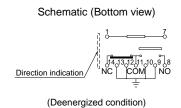
DIMENSIONS

mm inch

1. Standard PC board terminal

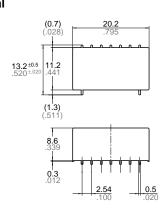


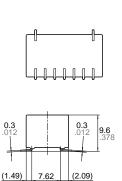




2. Surface mount terminal







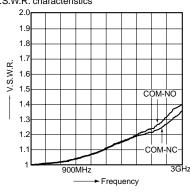
General tolerance: ±0.3 ±.012

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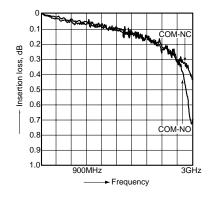
REFERENCE DATA

1. High frequency characteristics (Standard PC board terminal)

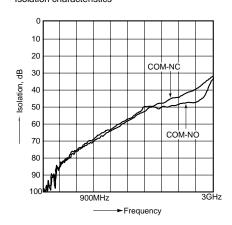
V.S.W.R. characteristics



Insertion loss characteristics



Isolation characteristics



NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%.

However, check it with the actual circuit since the characteristics may be slightly different.

2. Cleaning

For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick.

It is recommended that alcoholic solvents be used.

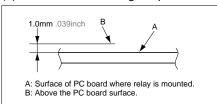
3. Soldering

1) The soldering shall be performed under following condition.

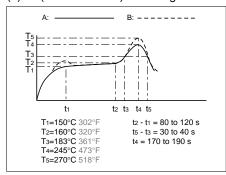
Max. 260°C 500°F 10s Max. 350°C 662°F 3s

The affect of the PCB on the relay will differ depending on the type of PCB used. Please verify the type of PCB to be used. Soldering time: within 5s

- In case of automatic soldering, the following conditions should be observed (Surface-mount terminal)
- (1) Position of measuring temperature



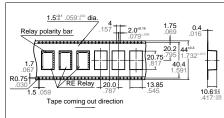
(2) IR (infrared reflow) soldering method



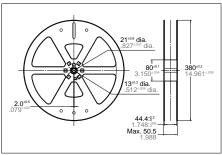
Temperature rise of relay itself may vary according to the mounting level or the heating method of reflow equipment. Therefore, please set the temperature of soldering portion of relay terminal and the top surface of the relay case not to exceed the above mentioned soldering condition. It is recommended to check the temperature rise of each portion under actual mounting condition before use.

4. Packing style

1) Tape dimensions



2) Dimensions of plastic reel



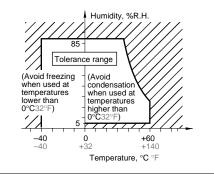
5. Conditions for operation, transport and storage

- 1) Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
- (1) Temperature:
- -40 to +60°C -40 to +140°F
- (2) Humidity: 5 to 85% RH

(Avoid freezing and condensation.)

The humidity range varies with the temperature. Use within the range indicated in the graph below.

(3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage:



2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.

3) Freezing

Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.

4) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.